TOSHIBA Intelligent Power Module Silicon N Channel IGBT

# MIG100J101H

### High Power Switching Applications Motor Control Applications

- Integrates inverter & control circuits (IGBT drive units, protection units for over-current, under-voltage & over-temperature) in one package.
- The electrodes are isolated from case.
- High speed type IGBT :  $V_{CE (sat)} = 2.5 \text{ V (Max.)}$

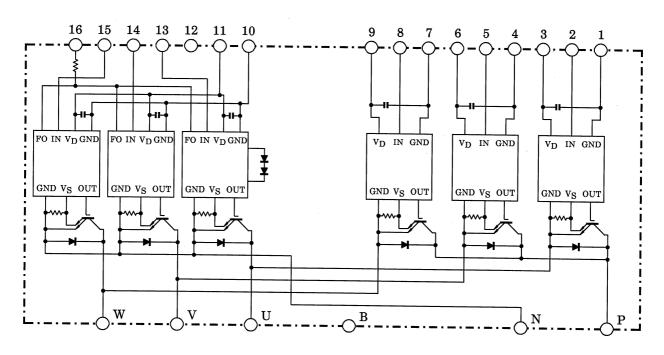
 $t_{off} = 3.0 \mu s \text{ (Max.)}$ 

 $t_{rr} = 0.30 \ \mu s \ (Max.)$ 

• Outline: TOSHIBA 2-110A1A

• Weight: 520 g

#### **Equivalent Circuit**



- 1. GND (U)
- 2. IN (U)
- 3. V<sub>D</sub> (U)
- 4. GND (V)
- 5. IN (V)
- 6. V<sub>D</sub> (V)

- 7. GND (W)
- 8. IN (W)
- 9. V<sub>D</sub> (W)
- 10. GND (L)
- 11. V<sub>D</sub> (L)
- 12. OPEN

- 13. IN (X)
- 14. IN (Y)
- 15. IN (Z)
- 16. FO

### Maximum Ratings ( $T_j = 25$ °C)

Stage	Characteristic	Condition	Symbol	Ratings	Unit
Inverter	Supply voltage	P-N power terminal	V <sub>CC</sub>	450	٧
	Collector-emitter voltage	_	V <sub>CES</sub>	600	V
	Collector current	T <sub>C</sub> = 25°C, DC	Ic	100	Α
	Forward current	T <sub>C</sub> = 25°C, DC	lF	100	Α
	Collector power dissipation	T <sub>C</sub> = 25°C	PC	300	W
	Junction temperature	_	Tj	150	°C
Control	Control supply voltage	V <sub>D</sub> -GND terminal	V <sub>D</sub>	20	V
	Input voltage	IN-GND terminal	V <sub>IN</sub>	20	V
	Fault output voltage	FO-GND (L) terminal	V <sub>FO</sub>	20	V
	Fault output current	FO sink current	I <sub>FO</sub>	14	mA
Module	Operating temperature	_	TC	-20 ~ +100	°C
	Storage temperature range	_	T <sub>stg</sub>	-40 ~ +125	°C
	Isolation voltage	AC 1 minute,	V <sub>ISO</sub>	2500	V
	Screw torque	M5	_	3	N·m

## Electrical Characteristics ( $T_j = 25$ °C)

### a. Inverter Stage

Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CEX</sub> V	V <sub>CE</sub> = 600 V	T <sub>j</sub> = 25°C	_	_	1	- mA
Collector cut-on current			T <sub>j</sub> = 125°C	_	_	20	
Collector-emitter saturation	Vo	VD 10 V, 10 100 / 1	T <sub>j</sub> = 25°C	_	2.0	2.5	V
voltage	VCE (sat)		T <sub>j</sub> = 125°C	_	2.0	_	l v
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 100 A		1	2.1	3.3	V
	t <sub>on</sub>	$V_{CC} = 300 \text{ V}, I_C = 100 \text{ A}$ $V_D = 15 \text{ V}, V_{IN} = 15 \text{ V} \leftrightarrow 0 \text{ V}$ Industry lead		1	1.0	2.0	- - μs
Switching time	t <sub>off</sub>			1	1.7	3.0	
Switching time	t <sub>f</sub>	Inductive load	(Note 1)	1	0.2	0.5	μο
	t <sub>rr</sub>		(NOTE 1)		0.1	0.3	

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## b. Control Stage (T<sub>j</sub> = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Control circuit current	High side	I <sub>D (H)</sub>	V <sub>D</sub> = 15 V		8	_	mA
	Low side	I <sub>D (L)</sub>			24	_	
Input-on signal voltage		V <sub>IN (on)</sub>	V <sub>D</sub> = 15 V, I <sub>C</sub> = 100 mA		1.5	1.7	V
Input-off signal voltage		V <sub>IN (off)</sub>	V <sub>D</sub> = 15 V, I <sub>C</sub> = 100 mA		2.5	2.8	V
Fault output current	Protection	I <sub>FO (on)</sub>	V 15 V	8	10	12	mA
	Normal	I <sub>FO (off)</sub>	V <sub>D</sub> = 15 V		_	1	IIIA
Over current protection trip level	Inverter	ос	V <sub>D</sub> = 15 V, T <sub>j</sub> = 125°C	160	200	_	А
Short current protection trip level	Inverter	SC	V <sub>D</sub> = 15 V, T <sub>j</sub> = 125°C	240	300	_	А
Over current cut-off time		t <sub>off (OC)</sub>	V <sub>D</sub> = 15 V	_	5	_	μs
Over temperature protection	Trip level	ОТ	Case temperature	110	118	125	°C
	Reset level	OTr		_	98	_	
Control supply under voltage protection	Trip level	UV	11.0 12.0		12.0	12.5	V
	Reset level	UVr		_	12.5	_	v
Fault output pulse width		t <sub>FO</sub>	V <sub>D</sub> = 15 V	1	2	3	ms

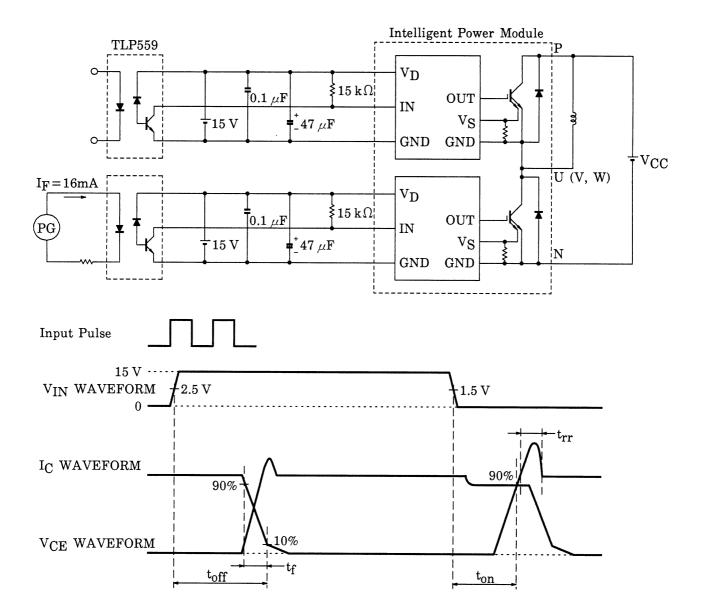
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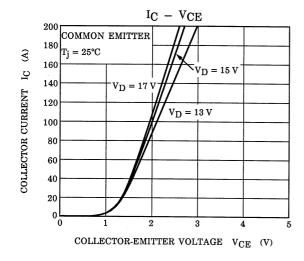
### c. Thermal Resistance ( $T_j = 25$ °C)

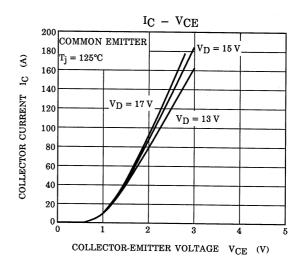
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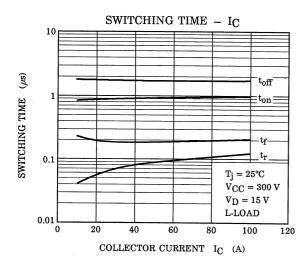
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Junction to case thermal resistance	D., a	Inverter IGBT stage	_	_	0.418	°C/W
ounction to case thermal resistance	R <sub>th (j-c)</sub>	Inverter FRD stage	-	-	1.000	
Case to fin thermal resistance	R <sub>th (c-f)</sub>	Compound is applied	_	0.05	_	°C/W

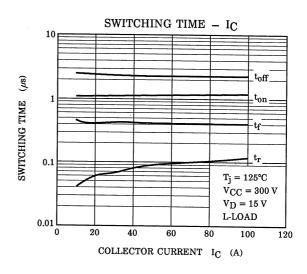
Note 1: Switching time test circuit & timing chart

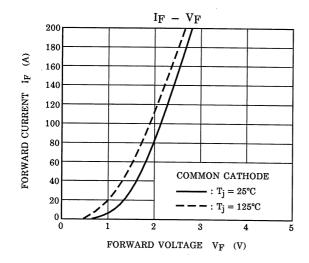


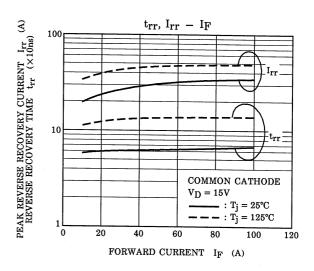




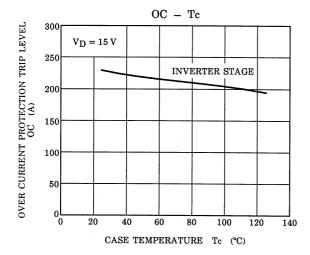


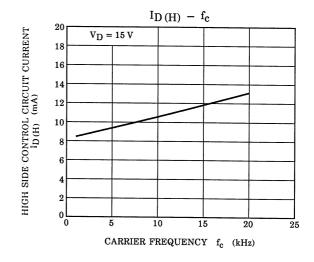


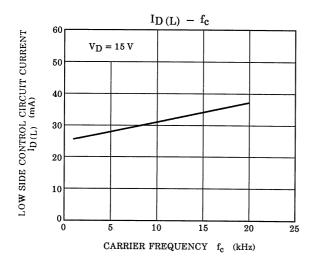


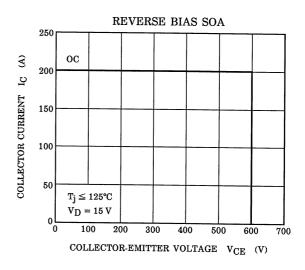


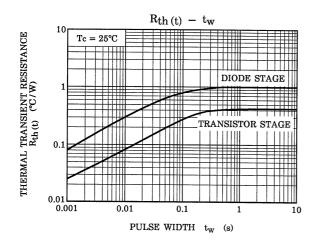
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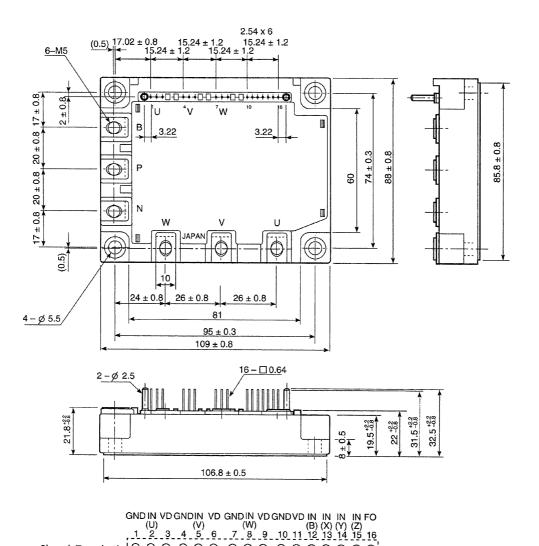




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### Package Dimensions: TOSHIBA 2-110A1A

Unit: mm



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